ememory

A Leading Logic NVM Company

November, 2014

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Outline

- Business Model
- Review of Operations for 3Q
- Growth Opportunity and Future Outlook
- Q & A



Business Model

- Founded in 2000. First customer engaged in 2002. Achieved profitability in 2005 and IPO in 2011. The largest logic non-volatile memory IP company, 216 employees (150 R&D).
- Since its IPO, the company initiated no new fund raising or bank debt, and has distributed in excess of 100% of earnings in cash dividends.
- Growth Indices: 1) No. of on-going technology platforms
 - 2) No. of design licenses
 - 3) Royalty

Upfront Licensing Fee =Technology and Design License



Worldwide Customers



	Taiwan	China	Korea	Japan	North America	Europe	Others
Foundry	5	6	3	2	1	0	1
IDM	0	0	0	8	2	1	0
Fabless	202	280	49	30	118	60	28













Powerchip力晶科技















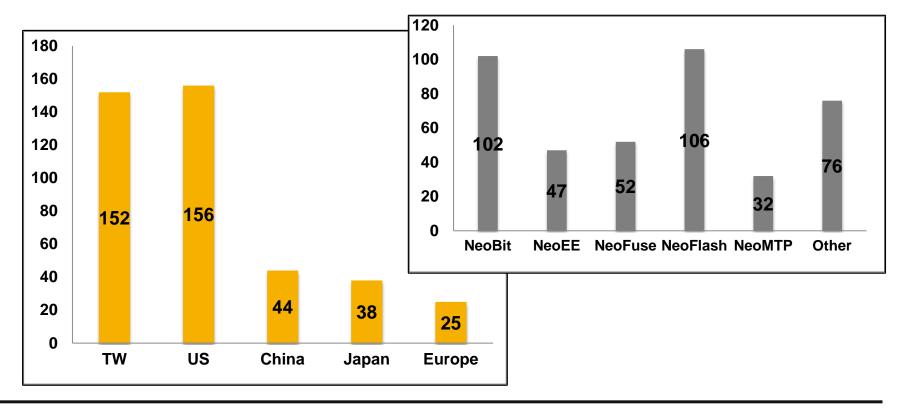






Patent Portfolio

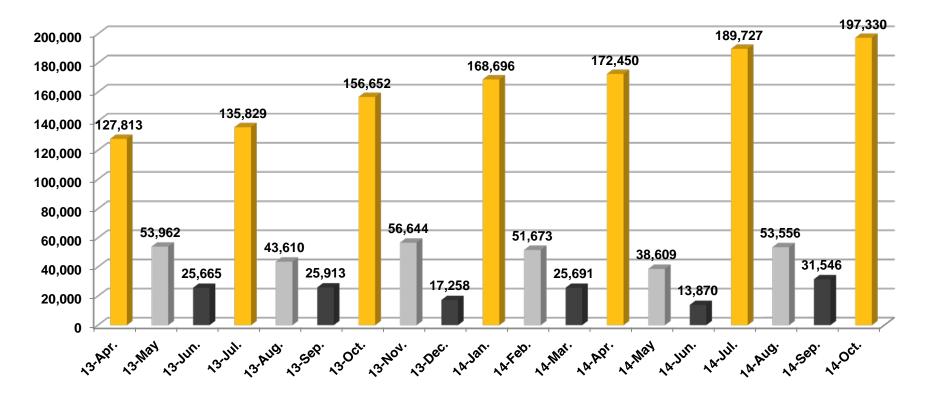
	2Q14	3Q14	Diff.
Pending	136	160	+24
Issued	236	255	+19
Total	372	415	+43



Quarterly Revenue Pattern

 The quarterly royalty from most of foundries are collected at first month of each quarter and from some other foundries are collected at second month, and none at third month.

Unit: NTD Thousands



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3Q Revenue Breakdown

Unit: NTD thousands

	3Q14	2Q14	QoQ Growth Rate	3Q13	YoY Growth Rate	1Q-3Q14	1Q-3Q13	YoY Growth Rate
Royalty	212,848	167,731	26.90%	148,297	43.53%	551,594	388,949	41.82%
Licensing	61,981	57,198	8.36%	57,055	8.63%	194,224	188,755	2.90%
Total	274,829	224,929	22.18%	205,352	33.83%	745,818	577,704	29.10%

Unit: Number of contract

		3Q14	2Q14	1Q-3Q14	1Q-3Q13
Technolog	y License	5	6	17	14
Design	NRE	22	12	67	39
License	Usage	88	86	264	230

Financial Income Statement

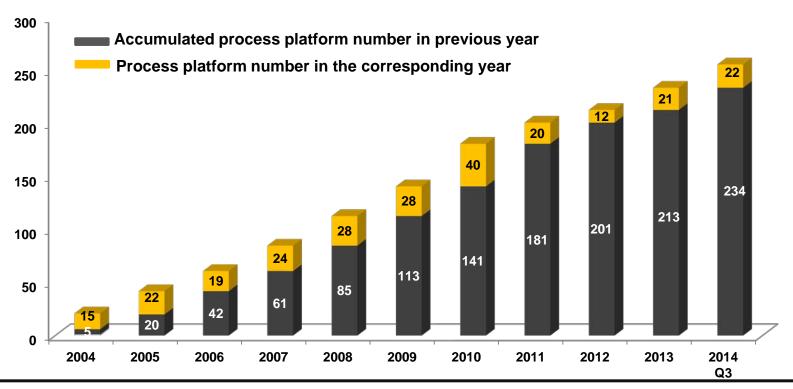
Unit: NTD thousands	3Q14	1Q-3Q14	1Q-3Q13	YoY
Revenue	274,829	745,818	577,704	29.1%
Gross Margin	100%	100%	100%	-
Operating Expenses	135,695	391,820	343,813	14.0%
Operating Margin	50.6%	47.5%	40.5%	+7.0ppts
Non Operating Income	1,852	6,943	654	961.6%
Net Income	124,352	317,673	199,372	59.3%
Net Margin	45.2%	42.6%	34.5%	+8.1ppts
EPS (Unit: NTD)	1.64	4.19	2.66	57.5%
ROE	29.7%	25.3%	17.2%	+8.1ppts

Technology License Statistics

Unit: Number of contract

Year	2012	2013	1Q-3Q2014
License number	12	19	17

Note: The terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



Current Technology Development Platform

- Total (As of October): 78
- 31 for NeoBit, 25 for NeoFuse, 2 for NeoFlash, 13 for NeoEE, and 7 for NeoMTP.

	16nm	28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25 um	Total
NeoBit	-	-	-	1	1	10	17	2	31
NeoFuse	1	7	4	8	1	3	1	-	25
NeoFlash	-	-	-	1	-	1	-	-	2
NeoEE	•	-	2	-	1	4	5	1	13
NeoMTP	ı	-	-	1	2	2	2	-	7

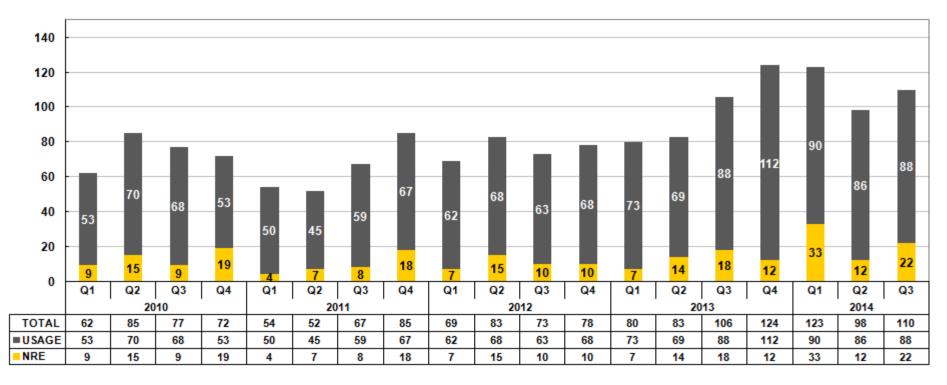
Current Technology Development Platform

12" Fabs	Production	Development	NVM Type	Process Type
16nm	0	1	OTP	FF+
28nm	2	7	ОТР	LP/HPM, HLP/HPM, LPS
40nm	1	6	OTP, MTP	HV-DDI, LP
55/65nm	7	11	OTP, MTP, Flash	LP, HV-DDI, HV-OLED, DRAM, CIS
80/90nm	7	5	OTP, MTP	HV-DDI, HV-OLED, LP
0.13/0.11um	1	5	OTP, Flash	HV-DDI, BCD, Generic
0.18um	0	1	ОТР	BCD

8" Fabs	Development	NVM Type	Process Type
0.13/0.11um	15	OTP, MTP, Flash	HV-DDI, BCD, LP, RF, CIS, LL
0.18/0.16/0.152um	24	ОТР, МТР	Generic, LP, LL, MR, HV, Green, BCD
0.25um	2	ОТР, МТР	BCD
0.35um	1	ОТР	UHV

Quarterly Design Licensing (New Tape Out)

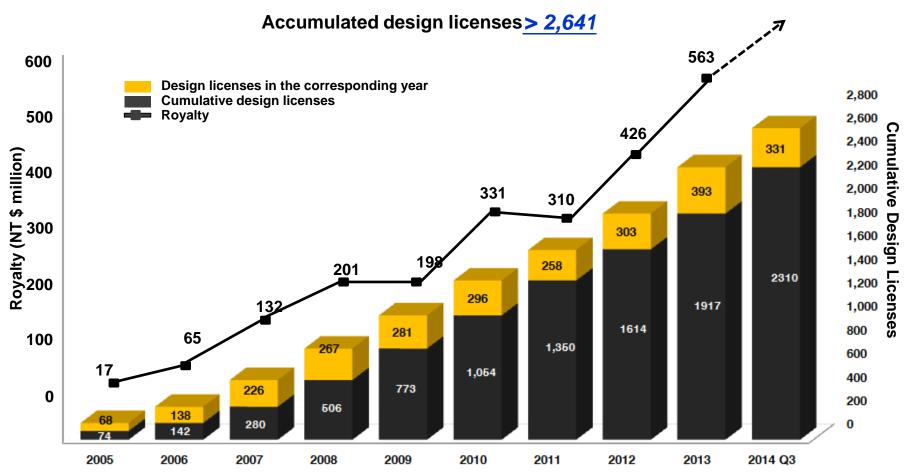
- Total 331 NTO as of 3Q 2014 (393@2013, 303@2012, 258@2011)



Usage: Usage of pre-qualified and verified IP (charged by per product tape out or annual package), the cycle time from design implementation to royalty payments for mass production is faster, typically less than one year.

NRE: NRE covers the customization of IP that must undergo new verification or qualification. It typically requires 1 to 1.5 years before resulting in royalty revenue.

Accumulated Licenses Drive Future Royalties

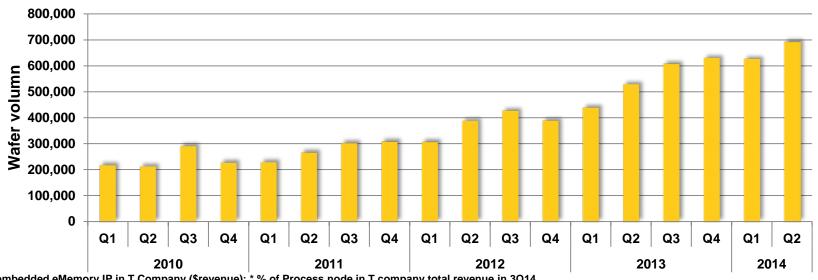


note 1: Due to the 2009 recession, royalty income was down annually 1.5%.

note 2: Pre-payment of royalty fees by a single customer contributed to 2010 annual growth of 67%, causing a drop of 6.3% in the following year, 2011.

note 3: CAGR for 2009-2013 was 30%.

Wafer Production Volume



embedded eMemory IP in T Company (\$revenue); * % of Process node in T company total revenue in 3Q14

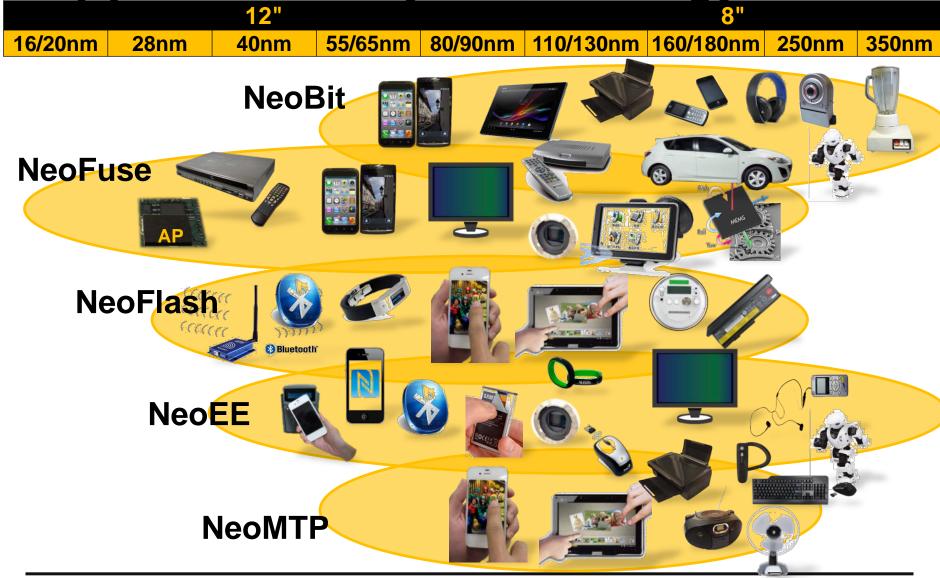
	Process node	*% of T	3Q14	2Q14	1Q-3Q14	1Q-3Q13
8"	0.5+	1%	0%	0%	0%	0%
	0.25/0.35	4%	33.5%	34.2%	30.5%	25.6%
	0.15/0.18	13%	13%	13.3%	13.3%	9.4%
	0.11/0.13	3%	21%	20.4%	20.8%	20.2%
12"	90nm	6%	16.4%	18.3%	16.3%	3.9%
	65nm	13%	0%	0%	0%	0%
	40/45nm	17%	0%	0%	0%	0%
	28nm	34%	0%	0%	0%	0%
	20nm	9%	0%	0%	0%	0%
8"		21%	16.5%	17%	16.1%	13.2%
12"		79%	1.4%	1.6%	1.4%	0.65%
Total		100%	4.5%	5.1%	4.5%	3.7%

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Applications by Technology



eMemory's NVM Technologies

- Logic NVM portfolio offers one-stop-shop solution.
 -) Compatible to any process
- Competitive macro sizes

> Robust structure

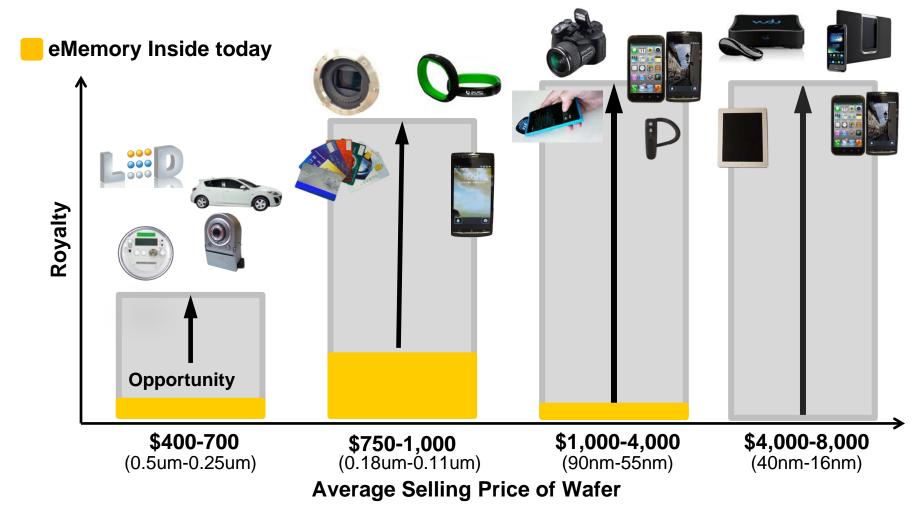
> Easy integration

> Low process cost

> Easy porting

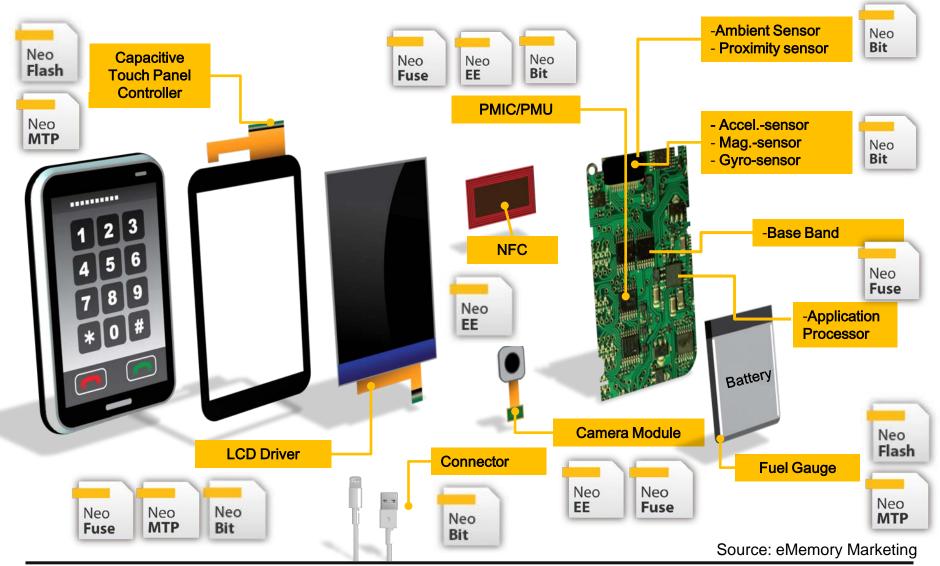
eMemory's NVM	0	ГР	MTP			
Technology	NeoBit	NeoFuse	NeoFlash	NeoEE	NeoMTP	
Product Type	ОТР	ОТР	Flash	EEPROM	MTP	
Endurance (Cycles)	10	10	1K~10K	10K~100K	1K~10K	
Additional Mask Steps	0	0	2-3	0	0	
Technology	Floating gate	Anti-Fuse	SONOS	Floating gate	Floating gate	
Scalability	Simple	Simple	Simple	Simple	Simple	
Memory Density	HD < 512Kb GHD < 16Mb	< 4Mb	< 2Mb	< 4Kb	< 512Kb	

Opportunity at all Price Points



Note: 2.2 million 8" equivalent wafers with eMemory IP were shipped in 2013. (~5% of WW foundry shipment)

eMemory IP in Smart Phone



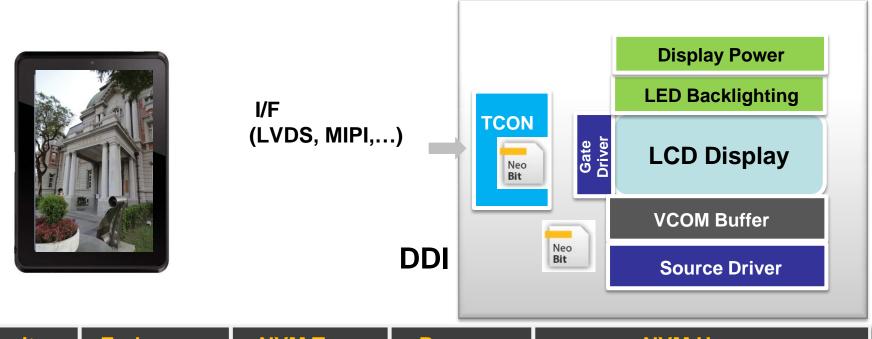
3Q14 Wafer Demand by IC Type

IC Type	Equ. to 8-inch wafer (K)		
AP	4964		
PMU	4756		
CIS sensor	4226		
Fingerprint	4000		
Smart card controller	3000		
Base Band	2935		
LCD driver (with TCON)	2013		
Gauge IC	627		
Touch panel controller (C)	556		
Connectivity	395		
STB controller	335		
TV controller	327		
Wifi controller	245		
LED driver	243		
DC-DC/AC-DC	176		
Accelerator sensor controller	124		
Light snesor	121		
Bluetooth controller	121		
Gyroscope sensor controller	104		
TAG IC	76		
DVD controller	67		
MCU (8bits, LV/3.3V)	56		
MCU (8bits, LV/3.3V)	56		
P-Gamma	52		
MCU (8bits, pure 5V)	51		
NB CAM controller	42		
Pressure sensor controller	20		
Touch pad controller	18		
PC CAM controller	15		
Touch panel controller (R)	5		
TCON (w/o driver)	4		

2014.8.29 updated

Advanced LCD Driver ICs

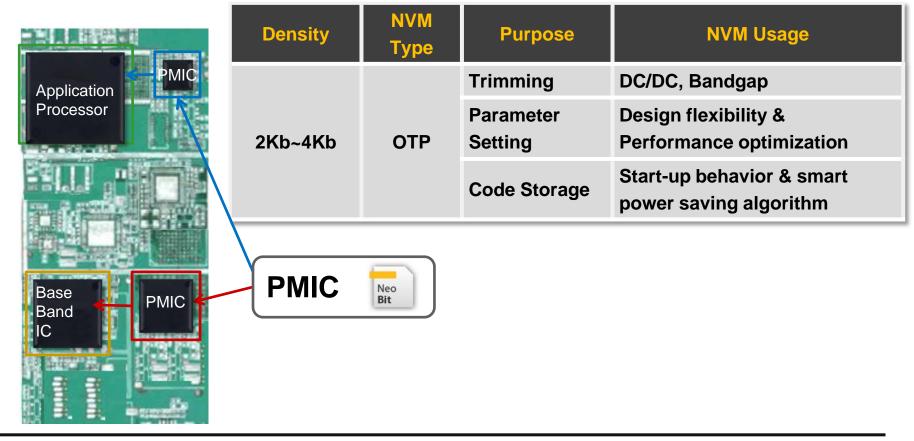
Process Technology: 0.11um HV/80nm HV/55nm HV



Density	Endurance	NVM Type	Purpose	NVM Usage
			Trimming	1. Accuracy enhancement
				2. Mismatch cancellation
2K8~4K8	1 OTP	Code	Ocala	1. Gamma Correction Table
			Storage	2. Timing Control Pattern
				3. Color Engine Enhancement

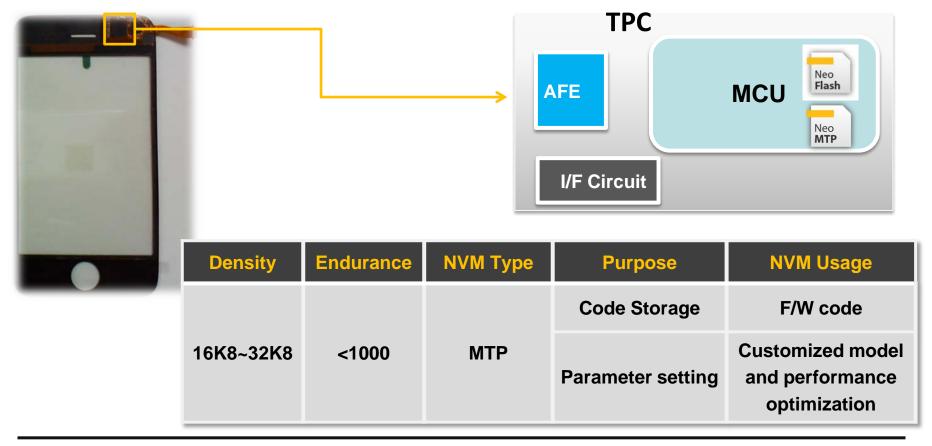
Power Management ICs for Baseband and Application Processor

Process Technology: Advanced 0.25um BCD/ 0.18um BCD/ 0.13um BCD Mature 0.18um/0.16um/0.152um Logic



Touch Panel Controller ICs

Process Technology: 0.16um HV/0.11um G

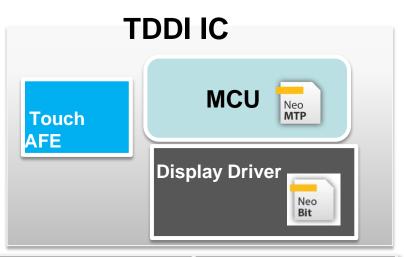


In-Cell Touch Panel Controllers ICs

Process Technology: 0.11um HV/80nm HV/55nm HV



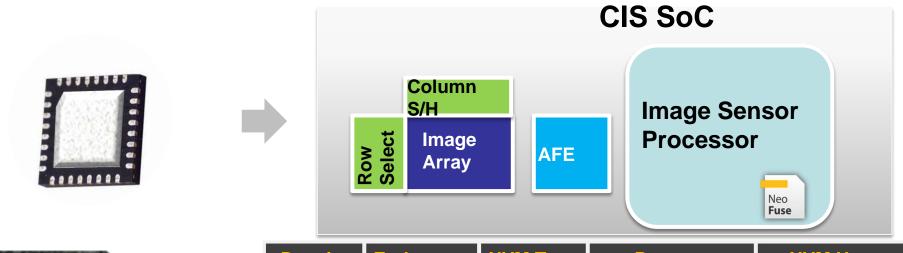


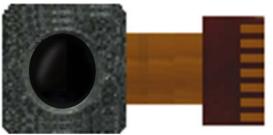


Density	Endurance	NVM Type	Purpose	NVM Usage
21/0 41/0	2K8~4K8 1 O	ОТР	Trimming	Accuracy
2N0~4N0		OIP	Code Storage	Gamma Table
16K8~32K8	<1000	MTP	Code Storage	Touch F/W Code
			Parameter setting	Performance
				Optimization

CMOS Image Sensor

Process Technology: 0.11um CIS/90nm CIS/65nm CIS

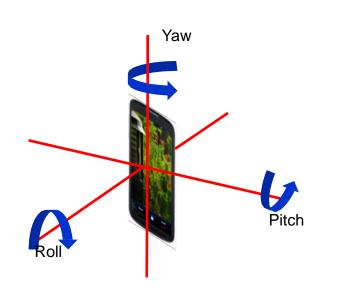


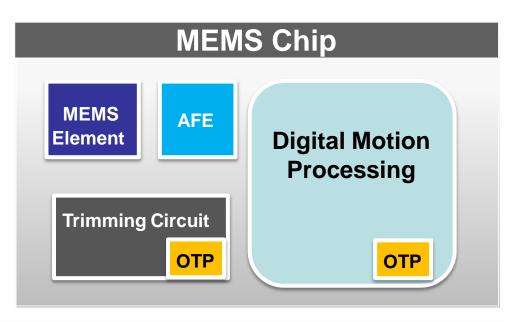


Density	Endurance	NVM Type	Purpose	NVM Usage
2Kb 4Kb	2Kb~4Kb 1 OTP P	Identification Setting	Product Code	
2ND~4ND		OIP	Parameter Setting	Start-up Initial Setting
32K8	1	OTP/ROM	Code Storage	Boot Load

MEMS

180/160/15x nm HV/Logic for MEMS Controller

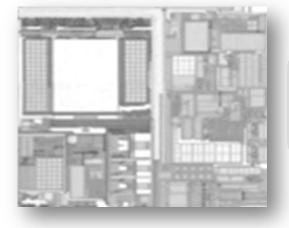




Density	NVM Type	Purpose	NVM Usage
2Kb~4Kb	OTP	Trimming	Factory trimming
	Parameter Setting	Signal filtering	
	Code Storage	Geometric computation	

Security & Protection

Authorized Product

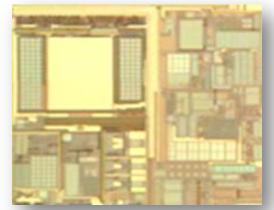


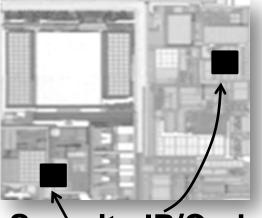
reverse copy

re-produce

without protection







reverse copy

re-produce

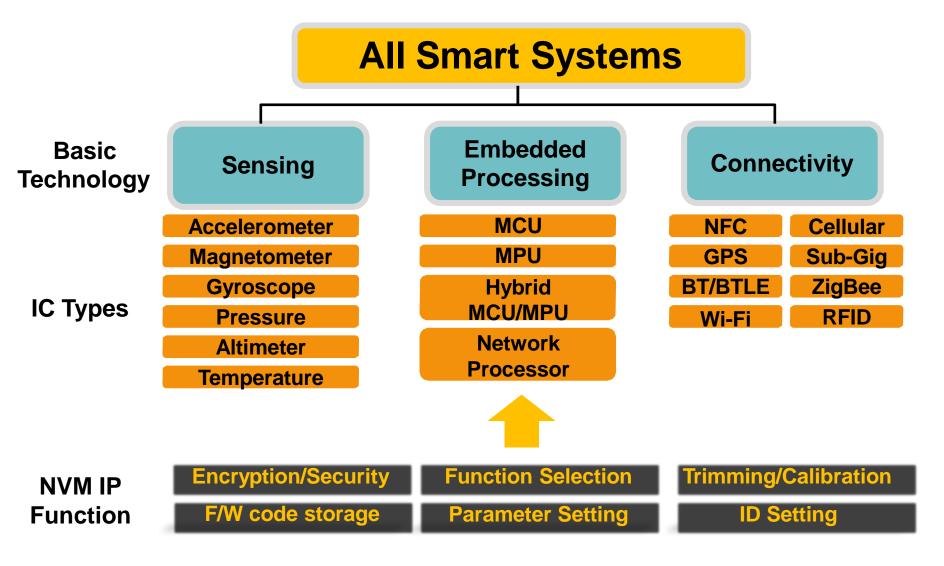
with protection

Security IP/Code by **Authorized Use**

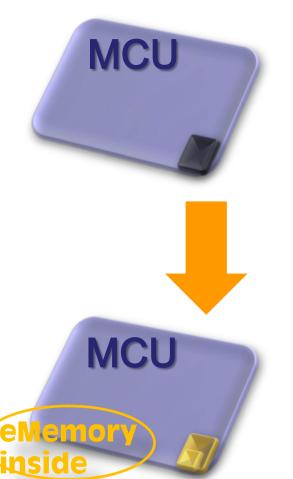
Can NOT Work w/o **Security IP/Code**



NVM IP Demand in IoT



Replacement of Embedded Flash for Competitiveness Improvement



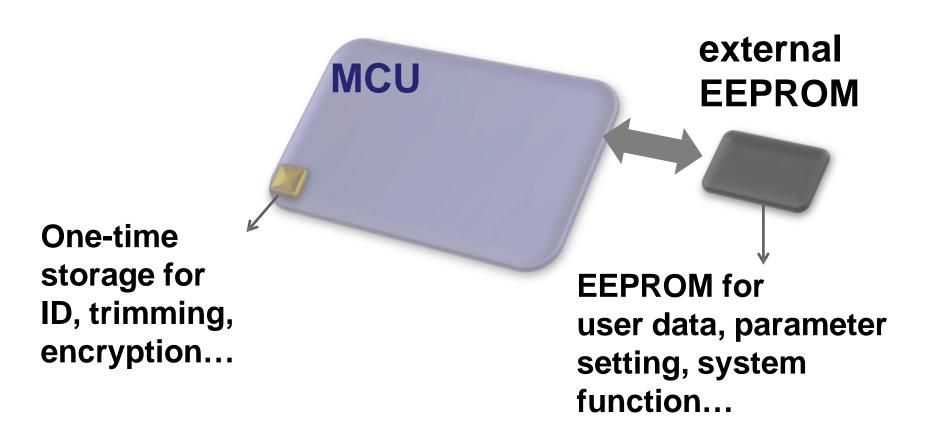
product design & manufacturing by embedded Flash Logic Process + 10 Masks

30% more cost reduction

wafer cost & testing time

product design & manufacturing by Embedded Logic NVM (OTP/MTP) Logic Process

MCU Applications with EEPROM



NeoBit + NeoEE

Hybrid NVM solution (NeoBit + NeoEE) with customized SPEC & optimized size



- One single IP by integration of NeoBit & NeoEE
- Help for system size reduction

Key Growth Drivers

Growth in value per mobile devices

More chip applications per smartphone/tablet product.

Growth into more markets

- From consumer electronics and mobile devices to wearable devices.
- Adding new NVM product lines further enable more product applications.

Growth in more advanced technology

• Higher royalty per wafer is contributed from more advanced technology nodes.

IoT great era

Embedded Logic NVM will be a must.

Outlook for 4Q and Beyond

- We foresee sustainable growth momentum in the coming quarters.
- Our penetration into advanced technology nodes is accelerating.
- The needs for low cost, low power and increased security are accelerating the adoption of eNVM in a diverse range of IoT-related applications.

Q & A

ememory

Embedded Wisely, Embedded Widely